

OKI Semiconductor

Network Solutions Oki for a Global Society

FEDR26V51253L-02-02 Issue Date: APR. 8, 2005

MR26V51253L

32M-Word \times 16-Bit or 64M-Word \times 8-Bit Page Mode P2ROM

FEATURES

- 33,554,432-word × 16-bit / 67,108,864-word × 8-bit electrically switchable configuration
- Page size of 8-word x 16-Bit or 16-word x 8-Bit
- 3.0 V to 3.6 V power supply
- Random Access time 100 ns MAX
- Page Access time 35 ns MAX
- Operating current 80 mA MAX
- Standby current 5 mA MAX
- Input/Output TTL compatible
- Three-state output

PACKAGES

MR26V51253L-xxxMB 70-pin plastic SSOP (P-SSOP70-500-0.80-K-MC)

P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

• Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.

· No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.

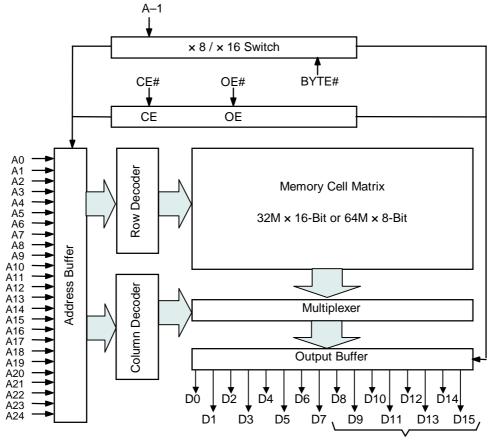
· No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.

• Custom Marking is available at no additional charge.

PIN CONF	ĪG	URATION	(Т	OP VIE
			1	
A11	1	0		CE#
A10	2		69	A12
A9	3		68	A13 A14
A8	4		67 66	A14 A15
A7	5			Vcc
A6 A5	7			A16
A5 A4	8			A17
A4 A3	9			A18
A3 A2			61	
	11			A20
A23				A21
NC			58	NC
NC	14		57	NC
NC	15		56	NC
NC	16		55	NC
NC	17		54	
GND	18	70SSOP	53	GND
NC	19		52	NC
NC	20		51	NC
NC	21		50	NC
NC	22		49	NC
NC			48	NC
BYTE#			47	A22
A0	_			A24
	26		45	
	27		44	D15/A-1 D7
D1	28		43 42	D7 D14
	29		42 41	D14
Vcc	30 31		41 40	D13
D2 D10	_		40 39	D13
	32 33		39 38	D12
D3 D11	33		30 37	D12
GND			36	Vcc
GND	<u> </u>			

W)

BLOCK DIAGRAM



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

PIN DESCRIPTIONS

Pin name	Functions
D15 / A–1	Data output / Address input
A0 to A24	Address inputs
D0 to D14	Data outputs
CE#	Chip enable input
OE#	Output enable input
BYTE#	Word / Byte select input
V _{cc}	Power supply voltage
V _{SS}	Ground
NC	No connect

FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	Н			D _{OUT}	
Read (8-Bit)	L	L	L	201/	D _{OUT}	Hi–Z	L/H
Output disable		Н	Н	3.0 V		Hi–Z	
Output disable	L	п	L	to 3.6 V			*
Standby	Н	*	Н	3.0 v		Hi–Z	
Standby	1	*	L				*

*: Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	—	–55 to 125	°C
Input voltage	VI		–0.5 to V _{CC} +0.5	V
Output voltage	Vo	Relative to V _{SS}	–0.5 to V _{CC} +0.5	V
Power supply voltage	V _{cc}		–0.5 to 5	V
Power dissipation per package	PD	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

					(Ta	= 0 to 70°C)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	V _{cc}		3.0	—	3.6	V
Input "H" level	VIH	V_{CC} = 3.0 to 3.6 V	2.2	—	V _{CC} +0.5*	V
Input "L" level	VIL		-0.5**	_	0.6	V

Voltage is relative to V_{SS} .

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

				$(V_{CC} = 3.)$	3 V, Ta = 25°	C, f = 1 MHz)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	$V_1 = 0 V$	_	_	16	
BYTE#	C _{IN2}	$v_1 = 0 v$	—	—	400	pF
Output	C _{OUT}	$V_0 = 0 V$	—	_	20	

ELECTRICAL CHARACTERISTICS

DC Characteristics

(V _{CC} = 3.0 V to 3.6 V, Ta = 0 to						
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}			10	μA
Output leakage current	I _{LO}	$V_{O} = 0$ to V_{CC}	_	_	10	μA
V _{CC} power supply current	Iccsc	$CE\# = V_{CC}$	_	_	5	mA
(Standby)	ICCST	CE# = V⊮	_	_	5	mA
V _{CC} power supply current (Read)	I _{CCA1}	$CE\# = V_{IL}, OE\# = V_{IH}$ f=5MHz	—	—	80	mA
Input "H" level	VIH	_	2.2		V _{CC} +0.5 *	V
Input "L" level	VIL	_	-0.5**		0.6	V
Output "H" level	V _{OH}	I _{ОН} = —1 mA	2.4	_	_	V
Output "L" level	V _{OL}	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS} .

* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

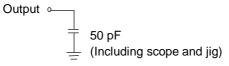
AC Characteristics

	(V _{CC} = 3.0 V to 3.6 V, Ta = 0 t						
Parameter	Symbol	Condition	Min.	Max.	Unit		
Address cycle time	t _C	—	100	—	ns		
Address access time	t _{ACC}	$CE\# = OE\# = V_{IL}$	—	100	ns		
Page cycle time	t _{PC}	—	35	—	ns		
Page access time	t _{PAC}	—	—	35	ns		
CE# access time	t _{CE}	$OE\# = V_{IL}$	—	100	ns		
OE# access time	t _{OE}	$CE\# = V_{IL}$	—	30	ns		
Output disable time	t _{CHZ}	$OE\# = V_{IL}$	0	20	ns		
	t _{OHZ}	$CE\# = V_{IL}$	0	20	ns		
Output hold time	t _{OH}	$CE\# = OE\# = V_{IL}$	0	_	ns		

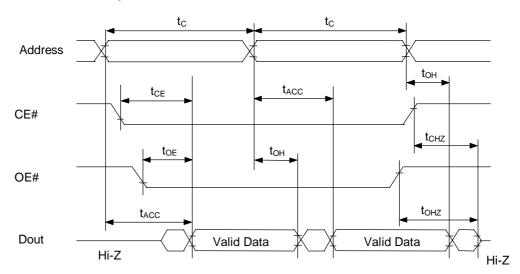
Measurement conditions

Input signal level------ 0 V/3.0 V Input timing reference level ------ 1/2Vcc Output load ------ 50 pF Output timing reference level ------ 1/2Vcc

Output load

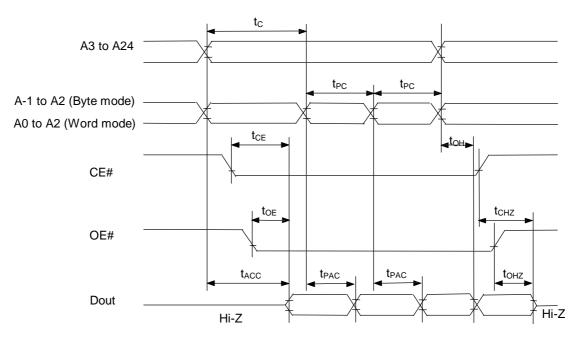


TIMING CHART (READ CYCLE)

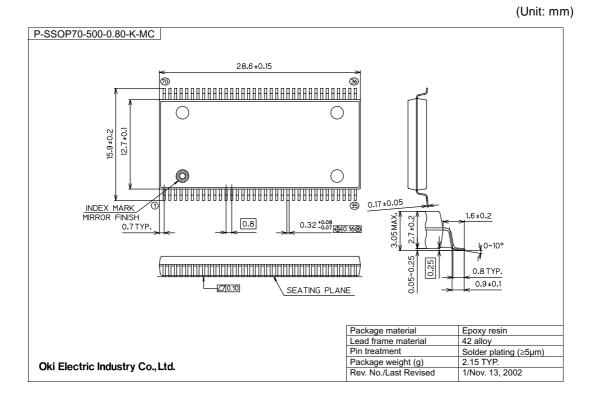


Random Access Mode Read Cycle

Page Access Mode Read Cycle



PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document		Page			
No.	Date	Date Previous Curre Edition Editi		Description	
FEDR26V51253L-02-01	Dec. 7, 2004	-	-	Final edition 1	
FEDR26V51253L-02-02	Apr.8, 2005	1,4	1,4	Change $t_{acc,} t_{ce}$ to 100ns from 120ns	

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